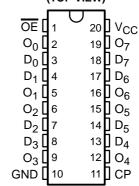
### CY54FCT374T, CY74FCT374T 8-BIT REGISTERS WITH 3-STATE OUTPUTS

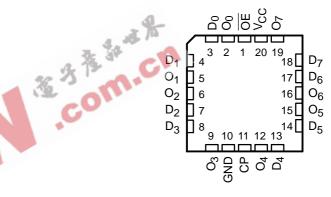
SCCS022A - MAY 1994 - REVISED OCTOBER 2001

- Function, Pinout, and Drive Compatible With FCT and F Logic
- Reduced V<sub>OH</sub> (Typically = 3.3 V) Versions of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Matched Rise and Fall Times
- Fully Compatible With TTL Input and Output Logic Levels
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- Edge-Triggered D-Type Inputs
- 250-MHz Typical Switching Rate
- CY54FCT374T
  - 32-mA Output Sink Current
  - 12-mA Output Source Current
- CY74FCT374T
  - 64-mA Output Sink Current
  - 32-mA Output Source Current
- 3-State Outputs

#### CY54FCT374T . . . D PACKAGE CY74FCT374T . . . P, Q, OR SO PACKAGE (TOP VIEW)



# CY54FCT374T . . . L PACKAGE (TOP VIEW)



#### description

The 'FCT374T devices are high-speed, low-power, octal D-type flip-flops, featuring separate D-type inputs for each flip-flop. These devices have 3-state outputs for bus-oriented applications. A buffered clock (CP) and output-enable ( $\overline{OE}$ ) inputs are common to all flip-flops. The eight flip-flops in the 'FCT374T store the state of their individual D inputs that meet the setup-time and hold-time requirements on the low-to-high CP transition. When  $\overline{OE}$  is low, the contents of the eight flip-flops are available at the outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state. The state of  $\overline{OE}$  does not affect the state of the flip-flops.

These devices are fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



#### **ORDERING INFORMATION**

| TA             | PAC       | KAGE†         | SPEED<br>(ns) | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>Marking |
|----------------|-----------|---------------|---------------|--------------------------|---------------------|
|                | QSOP – Q  | Tape and reel | 5.2           | CY74FCT374CTQCT          | FCT374C             |
|                | SOIC - SO | Tube          | 5.2           | CY74FCT374CTSOC          | FCT374C             |
|                | 3010 - 30 | Tape and reel | 5.2           | CY74FCT374CTSOCT         | F013/40             |
|                | DIP – P   | Tube          | 6.5           | CY74FCT374ATPC           | CY74FCT374ATPC      |
| 4000 to 0500   | QSOP – Q  | Tape and reel | 6.5           | CY74FCT374ATQCT          | FCT374A             |
| –40°C to 85°C  | SOIC - SO | Tube          | 6.5           | CY74FCT374ATSOC          | FCT374A             |
|                | 3010 - 30 | Tape and reel | 6.5           | CY74FCT374ATSOCT         | FC13/4A             |
|                | QSOP – Q  | Tape and reel | 10            | CY74FCT374TQCT           | FCT374              |
|                | SOIC - SO | Tube          | 10            | CY74FCT374TSOC           | FCT374              |
|                | 3010 - 30 | Tape and reel | 10            | CY74FCT374TSOCT          | FC13/4              |
|                | CDIP – D  | Tube          | 6.2           | CY54FCT374CTDMB          |                     |
|                | LCC – L   | Tube          | 6.2           | CY54FCT374CTLMB          |                     |
| –55°C to 125°C | CDIP – D  | Tube          | 7.2           | CY54FCT374ATDMB          |                     |
| -55 0 10 125 0 | LCC – L   | Tube          | 7.2           | CY54FCT374ATLMB          |                     |
|                | CDIP – D  | Tube          | 11            | CY54FCT374TDMB           |                     |
|                | LCC – L   | Tube          | 11            | CY54FCT374TLMB           |                     |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

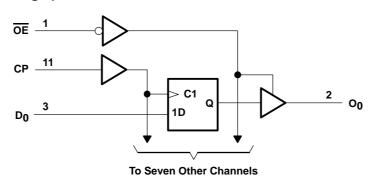
#### FUNCTION TABLE

|   | INPUTS     |    | OUTPUT |
|---|------------|----|--------|
| D | СР         | ŌĒ | 0      |
| Н | $\uparrow$ | L  | Н      |
| L | $\uparrow$ | L  | L      |
| X | Χ          | Н  | Z      |

H = High logic level, L = Low logic level, X = Don'tcare, Z = High-impedance state,

↑ = Low-to-high clock transition

### logic diagram (positive logic)





## CY54FCT374T, CY74FCT374T 8-BIT REGISTERS WITH 3-STATE OUTPUTS

SCCS022A - MAY 1994 - REVISED OCTOBER 2001

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range to ground potential DC input voltage range |                   |                  |
|---|-------------------|------------------|
| DC output voltage range   |                   | –0.5 V to 7 V    |
| DC output current (maximum sink current/pin)                    |                   | 120 mA           |
| Package thermal impedance, $\theta_{JA}$ (see Note 1):          | : P package       | 69°C/W           |
|   | Q package         | 68°C/W           |
|   | SO package        | 58°C/W           |
| Ambient temperature range with power applied,                   | l, T <sub>A</sub> | . −65°C to 135°C |
| Storage temperature range, T <sub>stg</sub>                     |                   | . −65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 2)

|                 |                                | CY5             | 4FCT374T | CY7  | 74FCT37 | 4T   | UNIT |
|-----------------|--------------------------------|-----------------|----------|------|---------|------|------|
|                 |                                | MIN             | NOM MAX  | MIN  | NOM     | MAX  | UNIT |
| VCC             | Supply voltage                 | 4.5             | 5 5.5    | 4.75 | 5       | 5.25 | V    |
| VIH             | High-level input voltage       | 2               | C        | 2    |         |      | V    |
| V <sub>IL</sub> | Low-level input voltage        | . 40            | 0.8      |      |         | 0.8  | V    |
| Іон             | High-level output current      | 0,              | -12      |      |         | -32  | mA   |
| loL             | Low-level output current       |                 | 32       |      |         | 64   | mA   |
| TA              | Operating free-air temperature | <del>-</del> 55 | 125      | -40  |         | 85   | °C   |

NOTE 2: All unused inputs of the device must be held at VCC or GND to ensure proper device operation.



NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

## CY54FCT374T, CY74FCT374T 8-BIT REGISTERS WITH 3-STATE OUTPUTS

SCCS022A - MAY 1994 - REVISED OCTOBER 2001

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETER        |                             | TEGT COMPITIONS  | C)   | /54FCT37 | '4T  | CY  | 74FCT37 | 4T   | UNIT |
|------------------|-----------------------------|--|------|----------|------|-----|---------|------|------|
| PARAMETER        |                             | TEST CONDITIONS  | MIN  | TYP†     | MAX  | MIN | TYP†    | MAX  | UNII |
| Maria            | $V_{CC} = 4.5 \text{ V},$   | I <sub>IN</sub> = -18 mA   |      | -0.7     | -1.2 |     |         |      | V    |
| VIK              | V <sub>CC</sub> = 4.75 V,   | I <sub>IN</sub> = -18 mA   |      |          |      |     | -0.7    | -1.2 | V    |
|                  | $V_{CC} = 4.5 \text{ V},$   | I <sub>OH</sub> = -12 mA   | 2.4  | 3.3      |      |     |         |      |      |
| Voн              | V <sub>CC</sub> = 4.75 V    | I <sub>OH</sub> = -32 mA   |      |          |      | 2   |         |      | V    |
|                  | VCC = 4.75 V                | I <sub>OH</sub> = −15 mA   |      |          |      | 2.4 | 3.3     |      |      |
| \/a.             | $V_{CC} = 4.5 \text{ V},$   | I <sub>OL</sub> = 32 mA  |      | 0.3      | 0.55 |     |         |      | V    |
| V <sub>OL</sub>  | $V_{CC} = 4.75 \text{ V},$  | I <sub>OL</sub> = 64 mA  |      |          |      |     | 0.3     | 0.55 | ٧    |
| $V_{hys}$        | All inputs                  |  |      | 0.2      |      |     | 0.2     |      | V    |
| 1.               | $V_{CC} = 5.5 \text{ V},$   | $V_{IN} = V_{CC}$  |      |          | 5    |     |         |      | μΑ   |
| Η                | $V_{CC} = 5.25 \text{ V},$  | $V_{IN} = V_{CC}$  |      |          |      |     |         | 5    | μΑ   |
|                  | $V_{CC} = 5.5 \text{ V},$   | $V_{IN} = 2.7 V$   |      |          | ±1   |     |         |      | μΑ   |
| lН               | $V_{CC} = 5.25 \text{ V},$  | $V_{IN} = 2.7 V$   |      |          | -    |     |         | ±1   | μΑ   |
| I <sub>IL</sub>  | $V_{CC} = 5.5 \text{ V},$   | $V_{IN} = 0.5 V$   |      |          | ±1   |     |         |      | μΑ   |
| ΊL               | $V_{CC} = 5.25 \text{ V},$  | $V_{IN} = 0.5 V$   |      | - 40     | -    |     |         | ±1   | μΛ   |
| l <sub>off</sub> | $V_{CC} = 0 V$ ,            | V <sub>OUT</sub> = 4.5 V   | a    | 13       | ±1   |     |         | ±1   | μΑ   |
| los‡             | $V_{CC} = 5.5 \text{ V},$   | V <sub>OUT</sub> = 0 V   | -60  | -120     | -225 |     |         |      | mA   |
| 105+             |                             | V <sub>OUT</sub> = 0 V   | 1130 | 0,,      |      | -60 | -120    | -225 | ША   |
| lozh             | $V_{CC} = 5.5 \text{ V},$   | V <sub>IN</sub> = 2.7 V  |      |          | 10   |     |         |      | μΑ   |
| 'OZH             | $V_{CC} = 5.25 \text{ V},$  | V <sub>IN</sub> = 2.7 V  |      |          |      |     |         | 10   | μΛ   |
| lozL             | $V_{CC} = 5.5 \text{ V},$   | V <sub>IN</sub> = 0.5 V  |      |          | -10  |     |         |      | μΑ   |
| 'OZL             | $V_{CC} = 5.25 \text{ V},$  | V <sub>IN</sub> = 0.5 V  |      |          |      |     |         | -10  | μΛ   |
| loo              | V <sub>CC</sub> = 5.5 V,    | $V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$ | '    | 0.1      | 0.2  |     |         |      | mA   |
| Icc              |                             | $V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$ |      |          |      |     | 0.1     | 0.2  | IIIA |
| Alco             |                             | $N = 3.4 \text{ V}$ , $f_1 = 0$ , Outputs open                       |      | 0.5      | 2    |     |         |      | mA   |
| ∇ICC             | V <sub>CC</sub> = 5.25 V, V | $IN = 3.4 \text{ V}$ , $f_1 = 0$ , Outputs open                      |      |          |      |     | 0.5     | 2    | ША   |

<sup>†</sup> Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, IOS tests should be performed last.

<sup>§</sup> Per TTL-driven input (V<sub>IN</sub> = 3.4 V); all other inputs at V<sub>CC</sub> or GND

SCCS022A - MAY 1994 - REVISED OCTOBER 2001

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

| PARAMETER          |   | TEST CONDITIO  | NC   | CY   | ′54FCT37 | '4T  | CY  | 74FCT37          | 4T   | UNIT |
|--------------------|---|--|--|------|----------|------|-----|------------------|------|------|
| PARAMETER          |   | TEST CONDITIO  | N3   | MIN  | TYP†     | MAX  | MIN | TYP <sup>†</sup> | MAX  | UNIT |
| I <sub>CCD</sub> ¶ | V <sub>CC</sub> = 5.5 V, Out<br>One bit switching<br>V <sub>IN</sub> ≤ 0.2 V or V <sub>I</sub>  |  | 0.06   | 0.12 |          |      |     | mA/              |      |      |
| ICCD.              | $V_{CC} = 5.25 \text{ V}$ , Outputs open,<br>One bit switching at 50% duty cycle, $\overline{OE} = \text{GND}$ ,<br>$V_{IN} \le 0.2 \text{ V}$ or $V_{IN} \ge V_{CC} - 0.2 \text{ V}$ |  |  |      |          |      |     | 0.06             | 0.12 | MHz  |
|                    |   | One bit<br>switching<br>at f <sub>1</sub> = 5 MHz      | $V_{IN} \le 0.2 \text{ V or}$<br>$V_{IN} \ge V_{CC} - 0.2 \text{ V}$ |      | 0.7      | 1.4  |     |                  |      |      |
|                    | $V_{CC} = 5.5 \text{ V},$ $f_0 = 10 \text{ MHz},$   | at 50% duty cycle                                      | V <sub>IN</sub> = 3.4 V or GND                                       |      | 1.2      | 3.4  |     |                  |      |      |
|                    | Outputs open,<br>OE = GND   | Eight bits<br>switching<br>at f <sub>1</sub> = 2.5 MHz | $V_{IN} \le 0.2 \text{ V or}$<br>$V_{IN} \ge V_{CC} - 0.2 \text{ V}$ |      | 1.6      | 3.2  |     |                  |      |      |
| l la               |   | at 50% duty cycle                                      | V <sub>IN</sub> = 3.4 V or GND                                       |      | - 35 11  | 12.2 |     |                  |      | mA   |
| IC                 |   | One bit<br>switching<br>at f <sub>1</sub> = 5 MHz      | $V_{IN} \le 0.2 \text{ V or}$<br>$V_{IN} \ge V_{CC} - 0.2 \text{ V}$ | 為    | C        | 7    |     | 0.7              | 1.4  | IIIA |
|                    | $V_{CC} = 5.25 \text{ V},$ $f_0 = 10 \text{ MHz},$  | at 50% duty<br>cycle                                   | $V_{IN} = 3.4 \text{ V} \text{ or GND}$                              | .0   | 18.0     |      |     | 1.2              | 3.4  |      |
|                    | Outputs open,<br>OE = GND   | Eight bits<br>switching<br>at f <sub>1</sub> = 2.5 MHz | $V_{IN} \le 0.2 \text{ V or}$<br>$V_{IN} \ge V_{CC} - 0.2 \text{ V}$ |      |          |      |     | 1.6              | 3.2  |      |
|                    |   | at 50% duty cycle                                      | $V_{IN} = 3.4 \text{ V or GND}$                                      |      |          |      |     | 3.9              | 12.2 |      |
| Ci                 |   |  |  |      | 5        | 10   |     | 5                | 10   | pF   |
| Co                 |   |  |  |      | 9        | 12   |     | 9                | 12   | pF   |

<sup>†</sup> Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ .

Where:

I<sub>C</sub> = Total supply current

ICC = Power-supply current with CMOS input levels

 $\Delta I_{CC}$  = Power-supply current for a TTL high input (V<sub>IN</sub> = 3.4 V)

D<sub>H</sub> = Duty cycle for TTL inputs high N<sub>T</sub> = Number of TTL inputs at D<sub>H</sub>

I<sub>CCD</sub> = Dynamic current caused by an input transition pair (HLH or LHL)

f<sub>0</sub> = Clock frequency for registered devices, otherwise zero

f<sub>1</sub> = Input signal frequency

N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the ICC formula.



This parameter is derived for use in total power-supply calculations.

 $<sup>^{\#}</sup>$ IC = ICC +  $\Delta$ ICC  $\times$  DH  $\times$  NT + ICCD (f<sub>0</sub>/2 + f<sub>1</sub>  $\times$  N<sub>1</sub>)

# **CY54FCT374T, CY74FCT374T 8-BIT REGISTERS** WITH 3-STATE OUTPUTS SCCS022A - MAY 1994 - REVISED OCTOBER 2001

#### timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                 |                                | CY54FCT374T |     | CY54FCT374AT |     | CY54FCT374CT |     | UNIT |
|-----------------|--------------------------------|-------------|-----|--------------|-----|--------------|-----|------|
|                 |                                | MIN         | MAX | MIN          | MAX | MIN          | MAX | UNIT |
| t <sub>W</sub>  | Pulse duration, CP high or low | 7           |     | 6            |     | 6            |     | ns   |
| t <sub>su</sub> | Setup time, data before CP↑    | 2           |     | 2            |     | 2            |     | ns   |
| th              | Hold time, data after CP↑      | 1.5         |     | 1.5          |     | 1.5          |     | ns   |

# timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                 |                                | CY74FCT374T |     | CY74FCT374AT |     | CY74FCT374CT |     | UNIT |
|-----------------|--------------------------------|-------------|-----|--------------|-----|--------------|-----|------|
|                 |                                | MIN         | MAX | MIN          | MAX | MIN          | MAX | UNIT |
| t <sub>W</sub>  | Pulse duration, CP high or low | 7           |     | 5            |     | 5            |     | ns   |
| t <sub>su</sub> | Setup time, data before CP↑    | 2           |     | 2            |     | 2            |     | ns   |
| th              | Hold time, data after CP↑      | 1.5         |     | 1.5          |     | 1.5          |     | ns   |

### switching characteristics over operating free-air temperature range (see Figure 1)

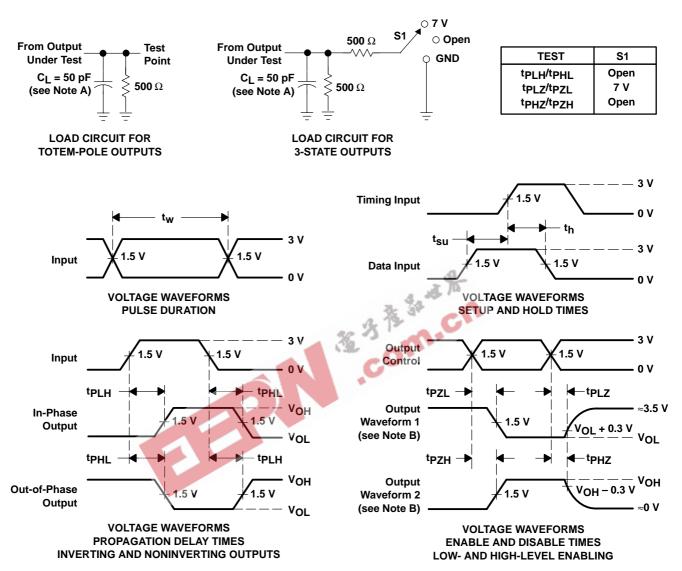
| PARAMETER        | FROM    | то       | CY54F | CT374T | CY54FCT | 374AT | CY54FC1 | 374CT | LINIT |
|------------------|---------|----------|-------|--------|---------|-------|---------|-------|-------|
| PARAMETER        | (INPUT) | (OUTPUT) | MIN   | MAX    | MIN     | MAX   | MIN     | MAX   | UNIT  |
| t <sub>PLH</sub> | СР      | 0        | 2     | 11     | 2       | 7.2   | 2       | 6.2   | ns    |
| <sup>t</sup> PHL | GF.     | O O      | 2     | 11     | 2       | 7.2   | 2       | 6.2   | 115   |
| <sup>t</sup> PZH | ŌĒ      | O        | 1.5   | 14     | 1.5     | 7.5   | 1.5     | 6.2   | ns    |
| tpzL             | OE      |          | 1.5   | 14     | 1.5     | 7.5   | 1.5     | 6.2   | 110   |
| t <sub>PHZ</sub> | ŌĒ      |          | 1.5   | 8      | 1.5     | 6.5   | 1.5     | 5.7   | 20    |
| t <sub>PLZ</sub> | UE .    | J        | 1.5   | 8      | 1.5     | 6.5   | 1.5     | 5.7   | ns    |

## switching characteristics over operating free-air temperature range (see Figure 1)

| PARAMETER        | FROM    | TO<br>(OUTPUT) | CY74F0 | CY74FCT374T |     | CY74FCT374AT |     | CY74FCT374CT |      |
|------------------|---------|----------------|--------|-------------|-----|--------------|-----|--------------|------|
| PARAMETER        | (INPUT) |                | MIN    | MAX         | MIN | MAX          | MIN | MAX          | UNIT |
| t <sub>PLH</sub> | СР      | 0              | 2      | 10          | 2   | 6.5          | 2   | 5.2          | 20   |
| <sup>t</sup> PHL | CF      | O              | 2      | 10          | 2   | 6.5          | 2   | 5.2          | ns   |
| <sup>t</sup> PZH | ŌĒ      | 0              | 1.5    | 12.5        | 1.5 | 6.5          | 1.5 | 5.5          |      |
| t <sub>PZL</sub> | OE .    | U              | 1.5    | 12.5        | 1.5 | 6.5          | 1.5 | 5.5          | ns   |
| <sup>t</sup> PHZ | ŌĒ      | 0              | 1.5    | 8           | 1.5 | 5.5          | 1.5 | 5            |      |
| t <sub>PLZ</sub> | ) OE    | 0              | 1.5    | 8           | 1.5 | 5.5          | 1.5 | 5            | ns   |

SCCS022A - MAY 1994 - REVISED OCTOBER 2001

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





i.com 24-May-2007

#### **PACKAGING INFORMATION**

| Orderable Device   | Status (1) | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | n MSL Peak Temp <sup>(3)</sup> |
|--------------------|------------|-----------------|--------------------|------|----------------|----------------------------|------------------|--------------------------------|
| 5962-9221802M2A    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| 5962-9221802MRA    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| 5962-9221804M2A    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| 5962-9221804MRA    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| 5962-9221806M2A    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| 5962-9221806MRA    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| 5962-9222203M2A    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| 5962-9222203MRA    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| 5962-9222205MRA    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| CY54FCT374ATDMB    | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| CY54FCT374ATLMB    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| CY54FCT374CTLMB    | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| CY54FCT374TDMB     | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type             |
| CY54FCT374TLMB     | ACTIVE     | LCCC            | FK                 | 20   | 135            | TBD 🧥                      | POST-PLATE       | N / A for Pkg Type             |
| CY54FCT574ATLMB    | ACTIVE     | LCCC            | FK                 | 20   | A13            | TBD                        | POST-PLATE       | N / A for Pkg Type             |
| CY74FCT374ATPC     | ACTIVE     | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type             |
| CY74FCT374ATPCE4   | ACTIVE     | PDIP            | N                  | 20   | <b>2</b> 0     | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type             |
| CY74FCT374ATQCT    | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374ATQCTE4  | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374ATQCTG4  | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374ATSOC    | ACTIVE     | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374ATSOCE4  | ACTIVE     | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374ATSOCG4  | ACTIVE     | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374ATSOCT   | ACTIVE     | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374ATSOCTE4 | ACTIVE     | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374ATSOCTG4 | ACTIVE     | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374CTQCT    | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374CTQCTE4  | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374CTQCTG4  | ACTIVE     | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR            |
| CY74FCT374CTSOC    | ACTIVE     | SOIC            | DW                 | 20   | 25             | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM             |
| CY74FCT374CTSOCE4  | ACTIVE     | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM             |





www.ti.com

24-May-2007

| Orderable Device   | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| CY74FCT374CTSOCG4  | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374CTSOCT   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374CTSOCTE4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374CTSOCTG4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TQCT     | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT374TQCTE4   | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT374TQCTG4   | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT374TSOC     | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TSOCE4   | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TSOCG4   | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TSOCT    | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TSOCTE4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT374TSOCTG4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATQCT    | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574ATQCTE4  | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574ATQCTG4  | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574ATSOC    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATSOCE4  | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATSOCG4  | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATSOCT   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATSOCTE4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574ATSOCTG4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574CTQCT    | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574CTQCTE4  | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574CTQCTG4  | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574CTSOC    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |



#### PACKAGE OPTION ADDENDUM

24-May-2007

| Orderable Device   | Status <sup>(1)</sup> | Dookowa         | Doolsono           | Dina | Doolsons | Fac Blan (2)               | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|-----------------|--------------------|------|----------|----------------------------|------------------|------------------------------|
| Orderable Device   | Status                | Package<br>Type | Package<br>Drawing | Pins | Qty      | Eco Plan (2)               | Lead/Ball Finish | MISE Peak Temp               |
| CY74FCT574CTSOCE4  | ACTIVE                | SOIC            | DW                 | 20   | 25       | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574CTSOCG4  | ACTIVE                | SOIC            | DW                 | 20   | 25       | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574CTSOCT   | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574CTSOCTE4 | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574CTSOCTG4 | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TQCT     | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500     | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574TQCTE4   | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574TQCTG4   | ACTIVE                | SSOP/<br>QSOP   | DBQ                | 20   | 2500     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR          |
| CY74FCT574TSOC     | ACTIVE                | SOIC            | DW                 | 20   | 25       | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TSOCE4   | ACTIVE                | SOIC            | DW                 | 20   | 25       | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TSOCG4   | ACTIVE                | SOIC            | DW                 | 20   | 25       | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TSOCT    | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TSOCTE4  | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT574TSOCTG4  | ACTIVE                | SOIC            | DW                 | 20   | 2000     | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take



#### PACKAGE OPTION ADDENDUM

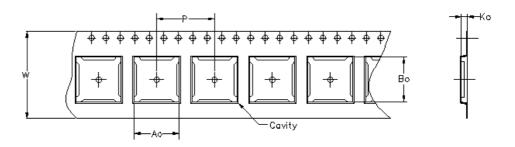
24-May-2007

reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

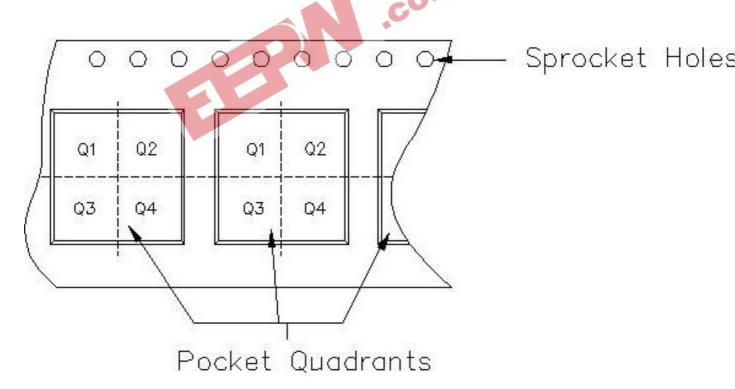






Carrier tape design is defined largely by the component lentgh, width, and thickness

| Ao = Dimension designed to accommodate the component width.     |  |  |  |  |  |  |  |
|---|--|--|--|--|--|--|--|
| Bo = Dimension designed to accommodate the component length.    |  |  |  |  |  |  |  |
| Ko = Dimension designed to accommodate the component thickness. |  |  |  |  |  |  |  |
| W = Overall width of the carrier tape. 🐪 🔥                      |  |  |  |  |  |  |  |
| P = Pitch between successive cavity benters.                    |  |  |  |  |  |  |  |



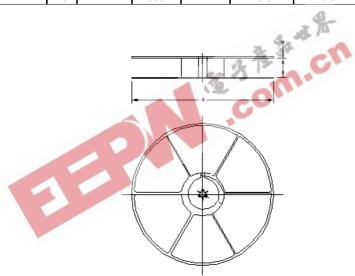
#### TAPE AND REEL INFORMATION





19-May-2007

| Device           | Package | Pins | Site | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------------|---------|------|------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| CY74FCT374ATQCT  | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT374ATSOCT | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| CY74FCT374CTQCT  | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT374CTSOCT | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| CY74FCT374TQCT   | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT374TSOCT  | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| CY74FCT574ATQCT  | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT574ATSOCT | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| CY74FCT574CTQCT  | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT574CTSOCT | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| CY74FCT574TQCT   | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| CY74FCT574TSOCT  | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |



#### **TAPE AND REEL BOX INFORMATION**

| Device Package   |     | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|------------------|-----|------|------|-------------|------------|-------------|
| CY74FCT374ATQCT  | DBQ | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| CY74FCT374ATSOCT | DW  | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| CY74FCT374CTQCT  | DBQ | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| CY74FCT374CTSOCT | DW  | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| CY74FCT374TQCT   | DBQ | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| CY74FCT374TSOCT  | DW  | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| CY74FCT574ATQCT  | DBQ | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| CY74FCT574ATSOCT | DW  | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| CY74FCT574CTQCT  | DBQ | 20   | MLA  | 0.0         | 0.0        | 0.0         |



## **PACKAGE MATERIALS INFORMATION**

19-May-2007

| Device           | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|------------------|---------|------|------|-------------|------------|-------------|
| CY74FCT574CTSOCT | DW      | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| CY74FCT574TQCT   | DBQ     | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| CY74FCT574TSOCT  | DW      | 20   | MLA  | 333.2       | 333.2      | 31.75       |



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products              |                        | Applications       |                           |
|-----------------------|------------------------|--------------------|---------------------------|
| Amplifiers            | amplifier.ti.com       | Audio              | www.ti.com/audio          |
| Data Converters       | dataconverter.ti.com   | Automotive         | www.ti.com/automotive     |
| DSP                   | dsp.ti.com             | Broadband          | www.ti.com/broadband      |
| Interface             | interface.ti.com       | Digital Control    | www.ti.com/digitalcontrol |
| Logic                 | logic.ti.com           | Military           | www.ti.com/military       |
| Power Mgmt            | power.ti.com           | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers      | microcontroller.ti.com | Security           | www.ti.com/security       |
| RFID                  | www.ti-rfid.com        | Telephony          | www.ti.com/telephony      |
| Low Power<br>Wireless | www.ti.com/lpw         | Video & Imaging    | www.ti.com/video          |
|                       |                        | Wireless           | www.ti.com/wireless       |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated